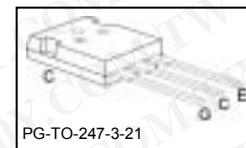
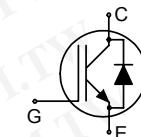


Low Loss DuoPack : IGBT in TrenchStop® technology with optimised diode

Features:

- Very low $V_{CE(sat)}$ 1.5 V (typ.)
- Maximum Junction Temperature 175 °C
- Short circuit withstand time – 5μs
- TrenchStop® and Fieldstop technology for 600 V applications offers :
 - very tight parameter distribution
 - high ruggedness, temperature stable behavior
 - low $V_{CE(sat)}$
- Positive temperature coefficient in $V_{CE(sat)}$
- Low EMI
- Low Gate Charge
- Qualified according to JEDEC¹ for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models : <http://www.infineon.com/igbt/>



Applications:

- Inductive Cooking
- Soft Switching Applications

Type	V_{CE}	I_C	$V_{CE(sat)}, T_J=25^\circ\text{C}$	$T_{j,\text{max}}$	Marking	Package
IHW30N60T	600V	30A	1.5V	175°C	H30T60	PG-T0-247-3-21

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V_{CE}	600	V
DC collector current, limited by $T_{j,\text{max}}$	I_C		A
$T_C = 25^\circ\text{C}$		60	
$T_C = 100^\circ\text{C}$		30	
Pulsed collector current, t_p limited by $T_{j,\text{max}}$	$I_{C\text{puls}}$	90	
Turn off safe operating area ($V_{CE} \leq 600\text{V}$, $T_j \leq 175^\circ\text{C}$)	-	90	
Diode forward current	I_F		
$T_C = 25^\circ\text{C}$		23	
$T_C = 100^\circ\text{C}$		13	
Diode pulsed current, t_p limited by $T_{j,\text{max}}$	$I_{F\text{puls}}$	30	
Gate-emitter voltage	V_{GE}	± 20	V
Transient Gate-emitter voltage ($t_p < 5\text{ ms}$)		± 25	
Short circuit withstand time ²	t_{SC}	5	μs
$V_{GE} = 15\text{V}$, $V_{CC} \leq 400\text{V}$, $T_j \leq 150^\circ\text{C}$			
Power dissipation $T_C = 25^\circ\text{C}$	P_{tot}	187	W
Operating junction temperature	T_j	-40...+175	°C
Storage temperature	T_{stg}	-55...+175	
Soldering temperature, 1.6mm (0.063 in.) from case for 10s	-	260	

¹ J-STD-020 and JESD-022

² Allowed number of short circuits: <1000; time between short circuits: >1s.



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Soft Switching Series

Thermal Resistance

Parameter	Symbol	Conditions	Max. Value	Unit
Characteristic				
IGBT thermal resistance, junction – case	R_{thJC}		0.8	K/W
Diode thermal resistance, junction – case	R_{thJCD}		1.1	
Thermal resistance, junction – ambient	R_{thJA}		40	

Electrical Characteristic, at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			min.	Typ.	max.	
Static Characteristic						
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{GE}=0\text{V}, I_C=0.5\text{mA}$	600	-	-	V
Collector-emitter saturation voltage	$V_{CE(\text{sat})}$	$V_{GE} = 15\text{V}, I_C=30\text{A}$ $T_j=25^\circ\text{C}$ $T_j=175^\circ\text{C}$	-	1.5	2	
Diode forward voltage	V_F	$V_{GE}=0\text{V}, I_F=10\text{A}$ $T_j=25^\circ\text{C}$ $T_j=150^\circ\text{C}$ $T_j=175^\circ\text{C}$	-	1.1	1.3	
Gate-emitter threshold voltage	$V_{GE(\text{th})}$	$I_C=0.43\text{mA}, V_{CE}=V_{GE}$	4.1	4.9	5.7	
Zero gate voltage collector current	I_{CES}	$V_{CE}=600\text{V}, V_{GE}=0\text{V}$ $T_j=25^\circ\text{C}$ $T_j=175^\circ\text{C}$	-	-	40 1000	μA
Gate-emitter leakage current	I_{GES}	$V_{CE}=0\text{V}, V_{GE}=20\text{V}$	-	-	100	nA
Transconductance	g_{fs}	$V_{CE}=20\text{V}, I_C=30\text{A}$	-	16.7	-	S
Integrated gate resistor	R_{Gint}		-			Ω

Dynamic Characteristic

Input capacitance	C_{iss}	$V_{CE}=25\text{V}, V_{GE}=0\text{V}, f=1\text{MHz}$	-	1630	-	pF
Output capacitance	C_{oss}		-	108	-	
Reverse transfer capacitance	C_{rss}		-	50	-	
Gate charge	Q_{Gate}	$V_{CC}=480\text{V}, I_C=30\text{A}$ $V_{GE}=15\text{V}$	-	167	-	nC
Internal emitter inductance measured 5mm (0.197 in.) from case	L_E		-	13	-	nH
Short circuit collector current ¹⁾	$I_{C(SC)}$	$V_{GE}=15\text{V}, t_{SC}\leq 5\mu\text{s}$ $V_{CC} = 400\text{V}, T_j = 150^\circ\text{C}$	-	275	-	A

¹⁾ Allowed number of short circuits: <1000; time between short circuits: >1s.



IHW30N60T

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Switching Characteristic, Inductive Load, at $T_J=25^\circ C$

Parameter	Symbol	Conditions	Value			Unit
			min.	Typ.	max.	
IGBT Characteristic						
Turn-on delay time	$t_{d(on)}$	$T_J=25^\circ C$, $V_{CC}=400V, I_C=30A$, $V_{GE}=0/15V$, $R_G=10.6 \Omega$, $L_\sigma^{(1)}=136nH$, $C_\sigma^{(1)}=39pF$	-	23	-	ns
Rise time	t_r		-	21	-	
Turn-off delay time	$t_{d(off)}$		-	254	-	
Fall time	t_f		-	46	-	
Turn-on energy	E_{on}		-	-	-	mJ
Turn-off energy	E_{off}		-	0.77	-	
Total switching energy	E_{ts}		-	0.77	-	

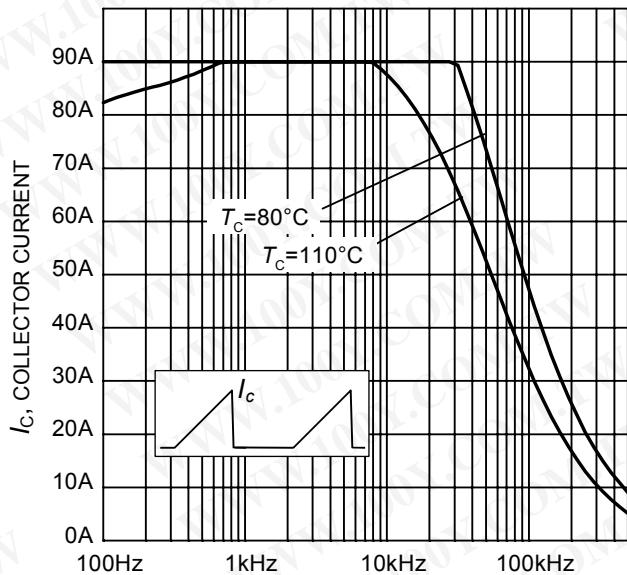
Switching Characteristic, Inductive Load, at $T_J=175^\circ C$

Parameter	Symbol	Conditions	Value			Unit
			min.	Typ.	max.	
IGBT Characteristic						
Turn-on delay time	$t_{d(on)}$	$T_J=175^\circ C$, $V_{CC}=400V, I_C=30A$, $V_{GE}=0/15V$, $R_G=10.6 \Omega$, $L_\sigma^{(1)}=136nH$, $C_\sigma^{(1)}=39pF$	-	24	-	ns
Rise time	t_r		-	26	-	
Turn-off delay time	$t_{d(off)}$		-	292	-	
Fall time	t_f		-	90	-	
Turn-on energy	E_{on}		-	-	-	mJ
Turn-off energy	E_{off}		-	1.1	-	
Total switching energy	E_{ts}		-	1.1	-	

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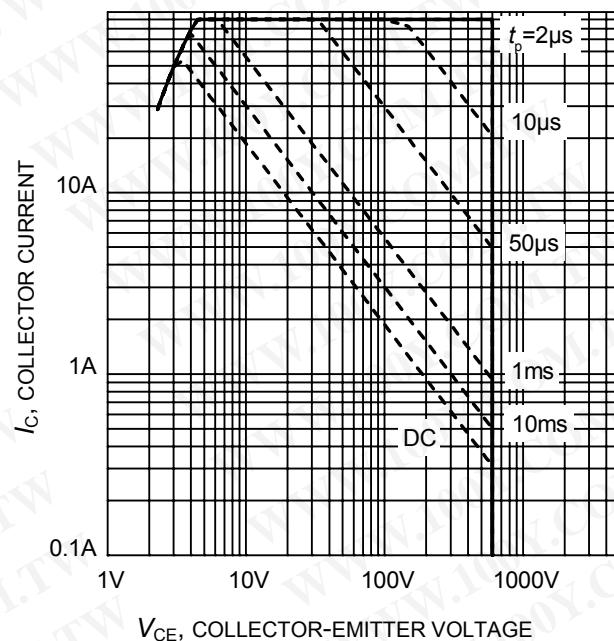
¹⁾ Leakage inductance L_σ and Stray capacity C_σ due to dynamic test circuit in Figure E.

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f , SWITCHING FREQUENCY

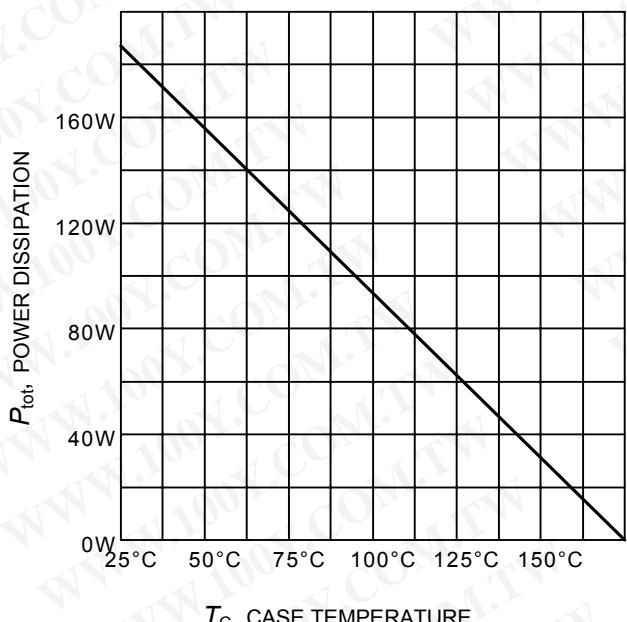
Figure 1. Collector current as a function of switching frequency for triangular current ($E_{\text{on}} = 0$, hard turn-off)
 $(T_j \leq 175^\circ\text{C}, D = 0.5, V_{\text{CE}} = 400\text{V}, V_{\text{GE}} = 0/+15\text{V}, R_{\text{G}} = 10\Omega)$



V_{CE} , COLLECTOR-EMITTER VOLTAGE

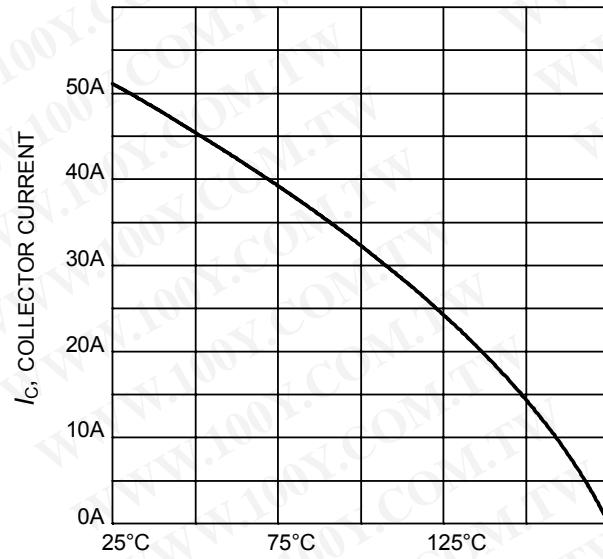
Figure 2. Safe operating area

$(D = 0, T_c = 25^\circ\text{C}, T_j \leq 175^\circ\text{C}; V_{\text{GE}}=15\text{V})$



T_c , CASE TEMPERATURE

Figure 3. Power dissipation as a function of case temperature
 $(T_j \leq 175^\circ\text{C})$



T_c , CASE TEMPERATURE

Figure 4. Collector current as a function of case temperature
 $(V_{\text{GE}} \geq 15\text{V}, T_j \leq 175^\circ\text{C})$

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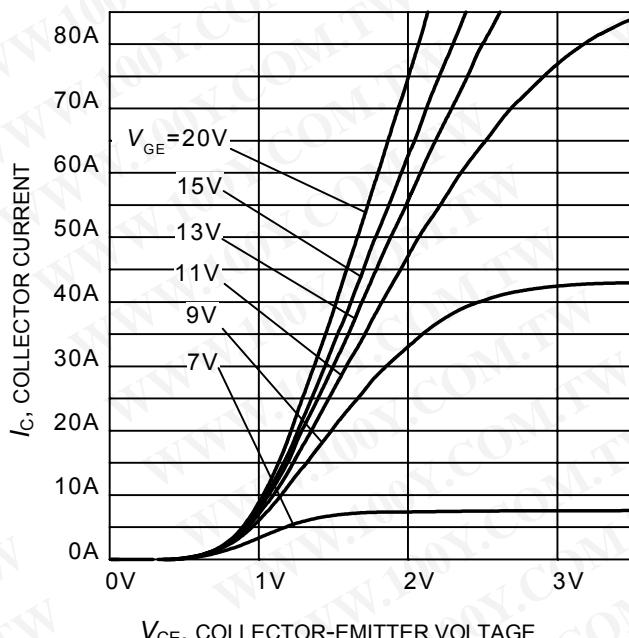


Figure 5. Typical output characteristic
 $(T_j = 25^\circ\text{C})$

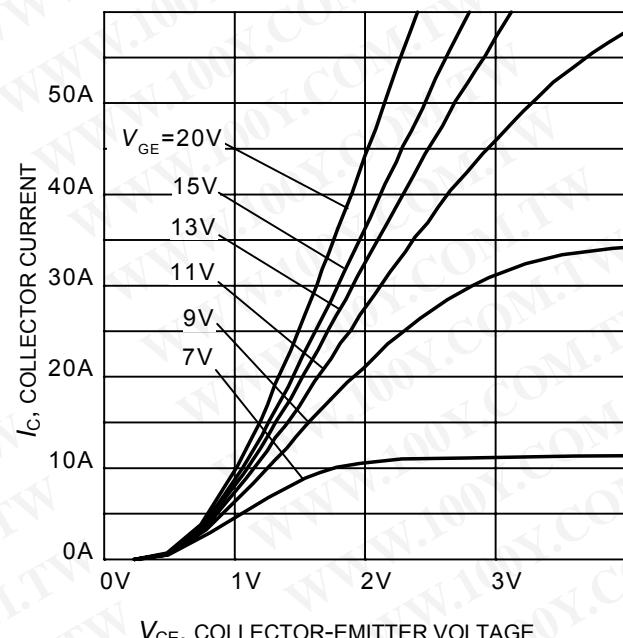


Figure 6. Typical output characteristic
 $(T_j = 175^\circ\text{C})$

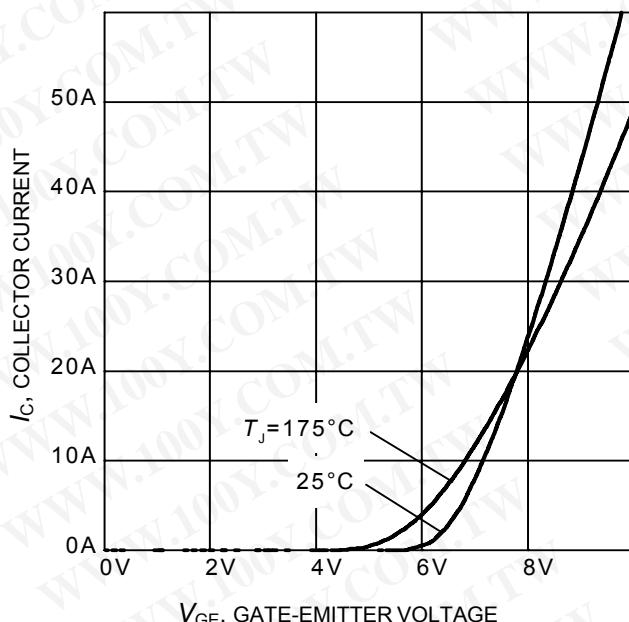


Figure 7. Typical transfer characteristic
 $(V_{CE} = 10\text{V})$

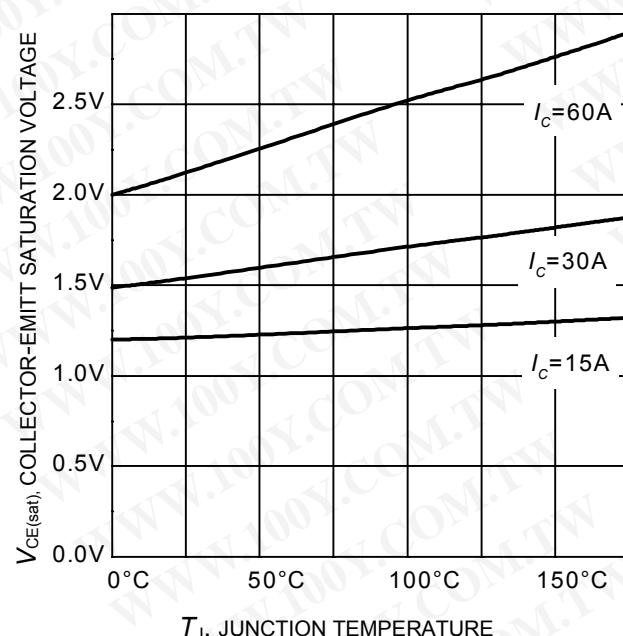
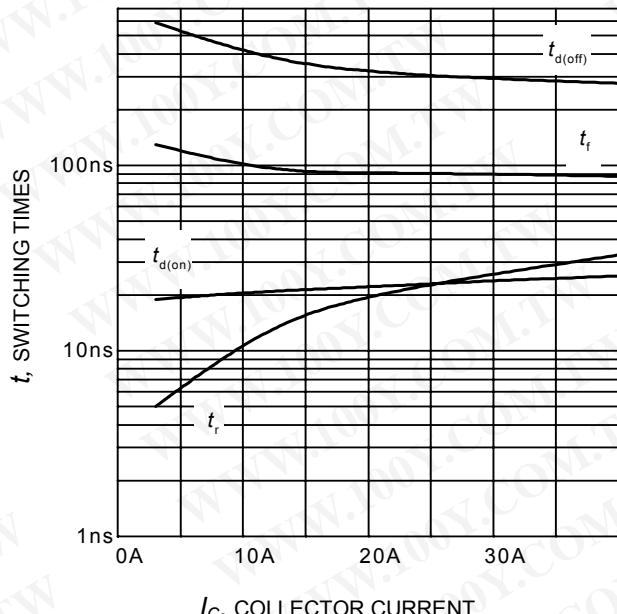


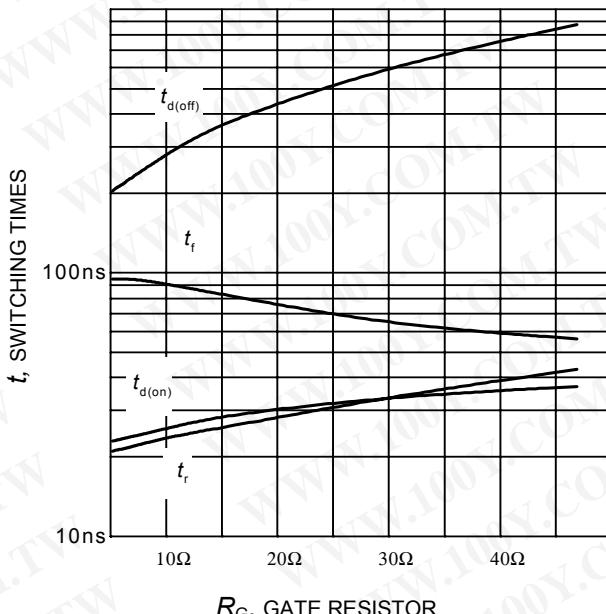
Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature
 $(V_{GE} = 15\text{V})$

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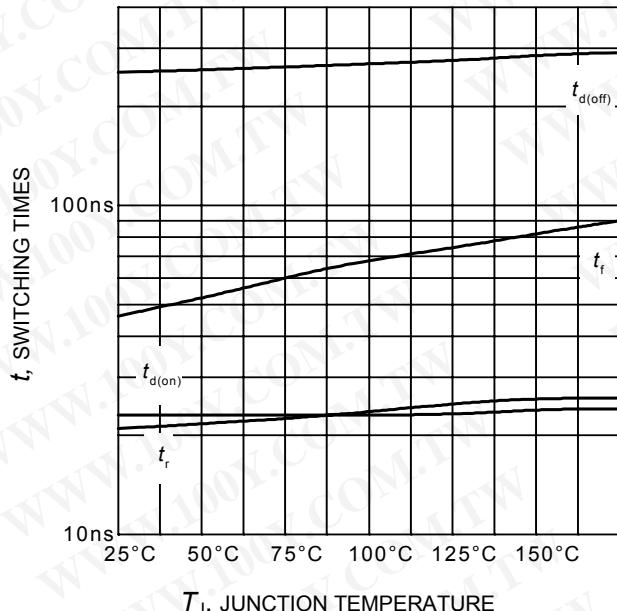
I_C , COLLECTOR CURRENT

Figure 9. Typical switching times as a function of collector current
 (inductive load, $T_J = 175^\circ\text{C}$,
 $V_{CE} = 400\text{V}$, $V_{GE} = 0/15\text{V}$, $R_G = 10\Omega$,
 Dynamic test circuit in Figure E)



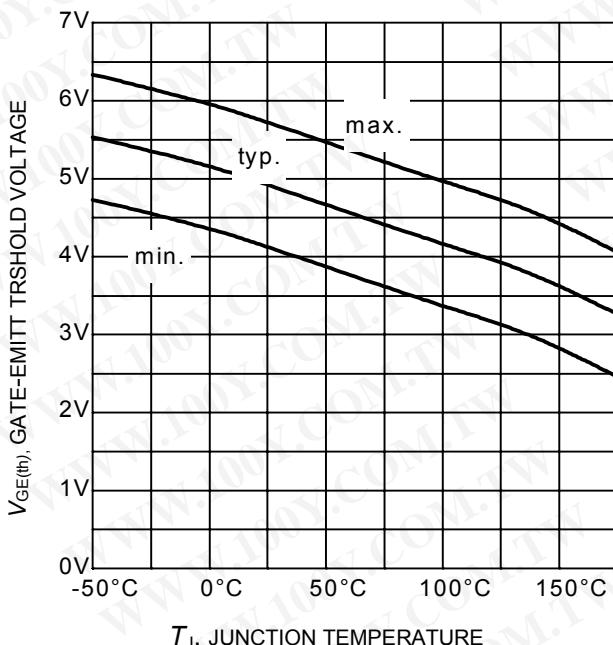
R_G , GATE RESISTOR

Figure 10. Typical switching times as a function of gate resistor
 (inductive load, $T_J = 175^\circ\text{C}$,
 $V_{CE} = 400\text{V}$, $V_{GE} = 0/15\text{V}$, $I_C = 30\text{A}$,
 Dynamic test circuit in Figure E)



T_J , JUNCTION TEMPERATURE

Figure 11. Typical switching times as a function of junction temperature
 (inductive load, $V_{CE} = 400\text{V}$,
 $V_{GE} = 0/15\text{V}$, $I_C = 30\text{A}$, $R_G = 10\Omega$,
 Dynamic test circuit in Figure E)



T_J , JUNCTION TEMPERATURE

Figure 12. Gate-emitter threshold voltage as a function of junction temperature
 $(I_C = 0.43\text{mA})$

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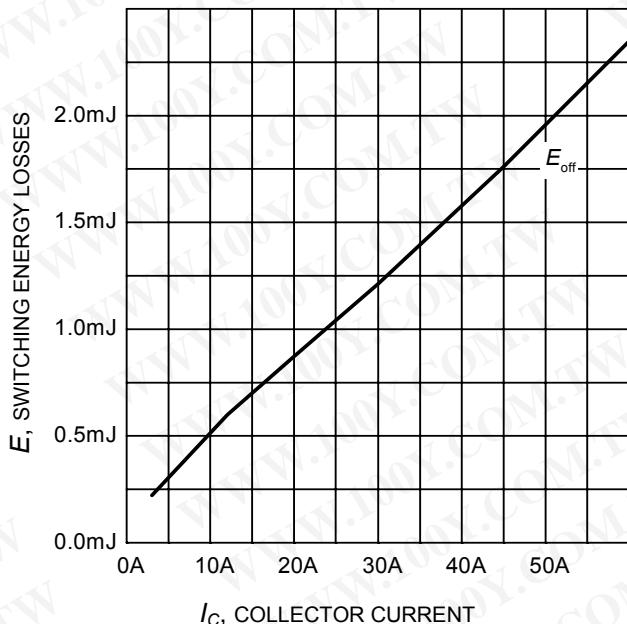


Figure 13. Typical switching energy losses as a function of collector current
 (inductive load, $T_J = 175^\circ\text{C}$,
 $V_{CE} = 400\text{V}$, $V_{GE} = 0/15\text{V}$, $R_G = 10\Omega$,
 Dynamic test circuit in Figure E)

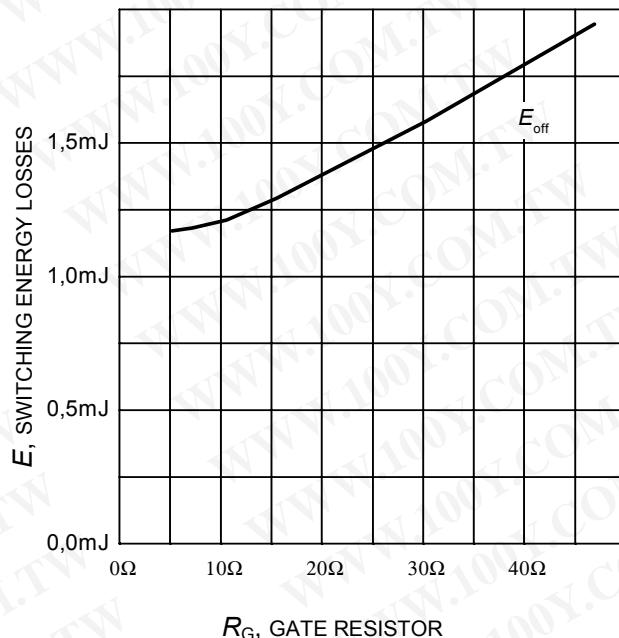


Figure 14. Typical switching energy losses as a function of gate resistor
 (inductive load, $T_J = 175^\circ\text{C}$,
 $V_{CE} = 400\text{V}$, $V_{GE} = 0/15\text{V}$, $I_C = 30\text{A}$,
 Dynamic test circuit in Figure E)

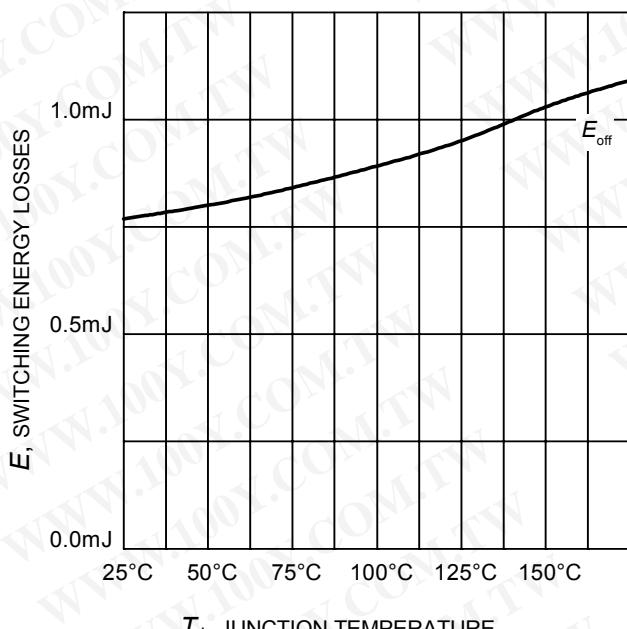


Figure 15. Typical switching energy losses as a function of junction temperature
 (inductive load, $V_{CE} = 400\text{V}$,
 $V_{GE} = 0/15\text{V}$, $I_C = 30\text{A}$, $R_G = 10\Omega$,
 Dynamic test circuit in Figure E)

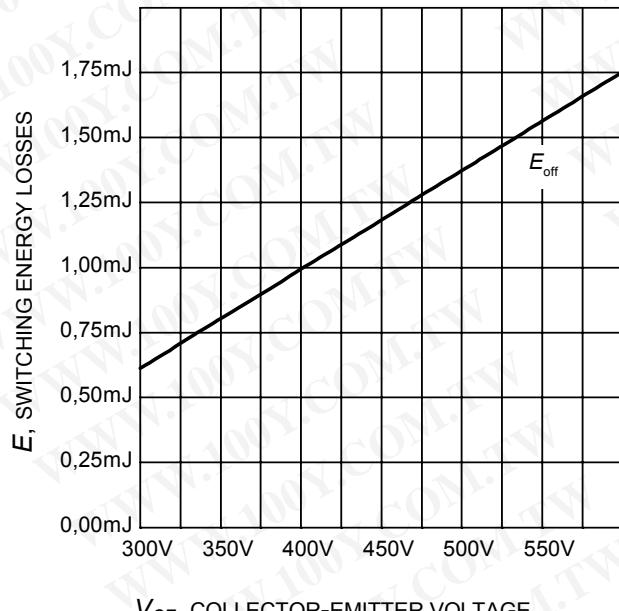


Figure 16. Typical switching energy losses as a function of collector emitter voltage
 (inductive load, $T_J = 175^\circ\text{C}$,
 $V_{GE} = 0/15\text{V}$, $I_C = 30\text{A}$, $R_G = 10\Omega$,
 Dynamic test circuit in Figure E)

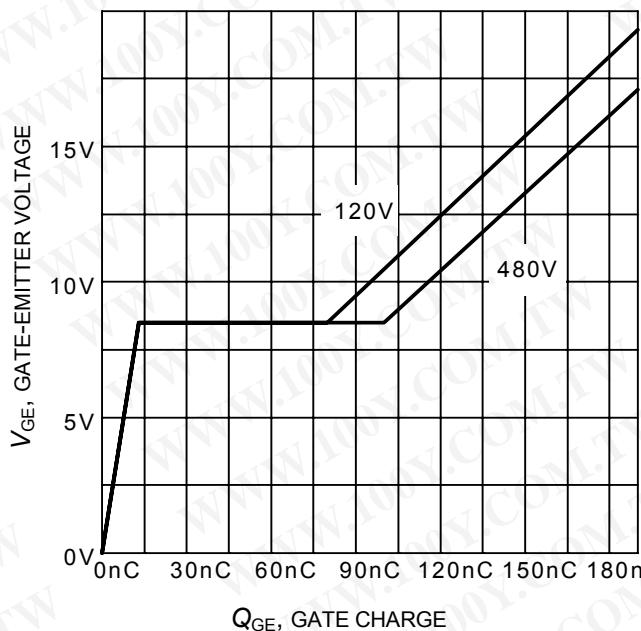


Figure 17. Typical gate charge
($I_C=30$ A)

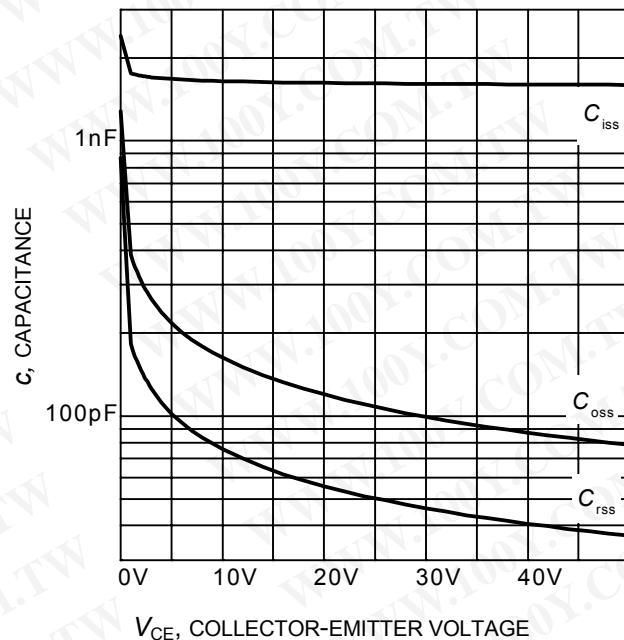


Figure 18. Typical capacitance as a function
of collector-emitter voltage
($V_{GE}=0$ V, $f=1$ MHz)

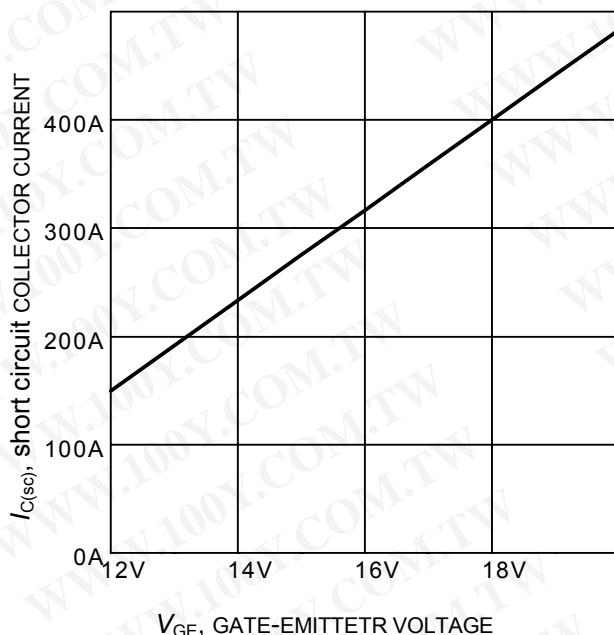


Figure 19. Typical short circuit collector
current as a function of gate-
emitter voltage
($V_{CE} \leq 400$ V, $T_j \leq 150^\circ$ C)

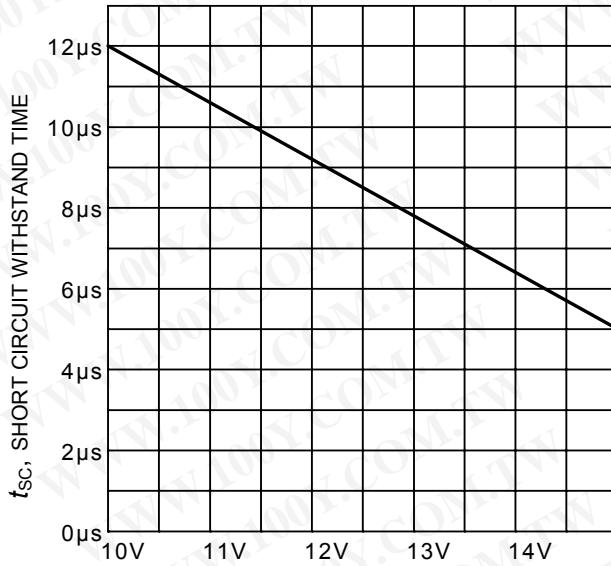
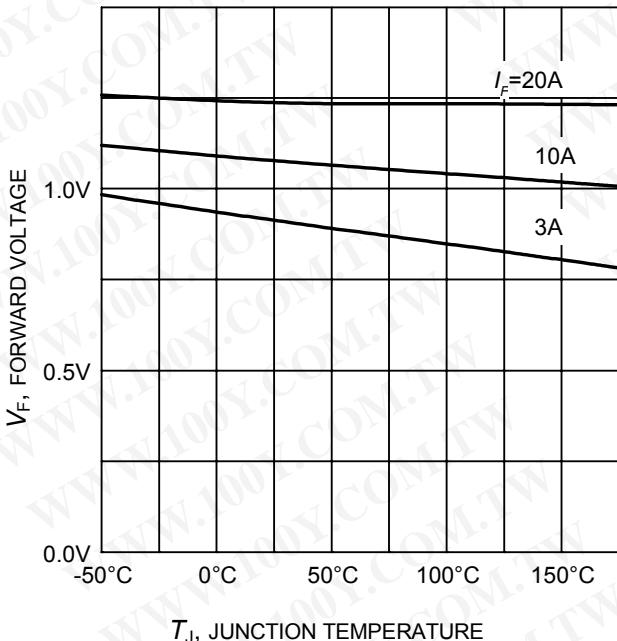
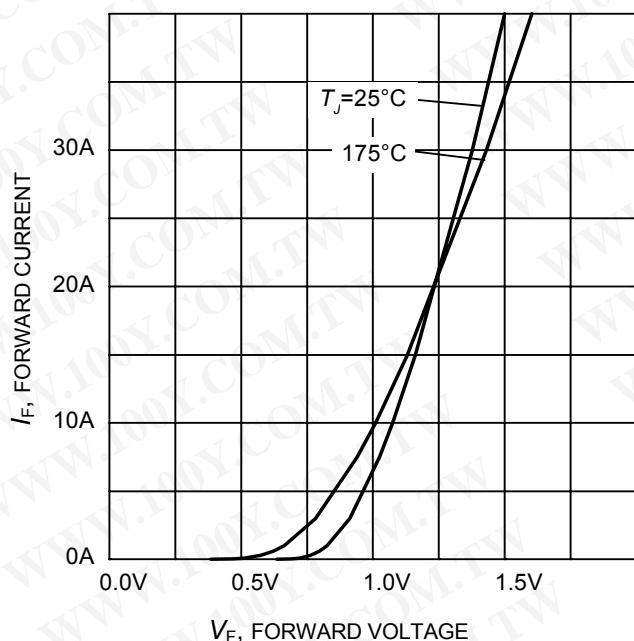
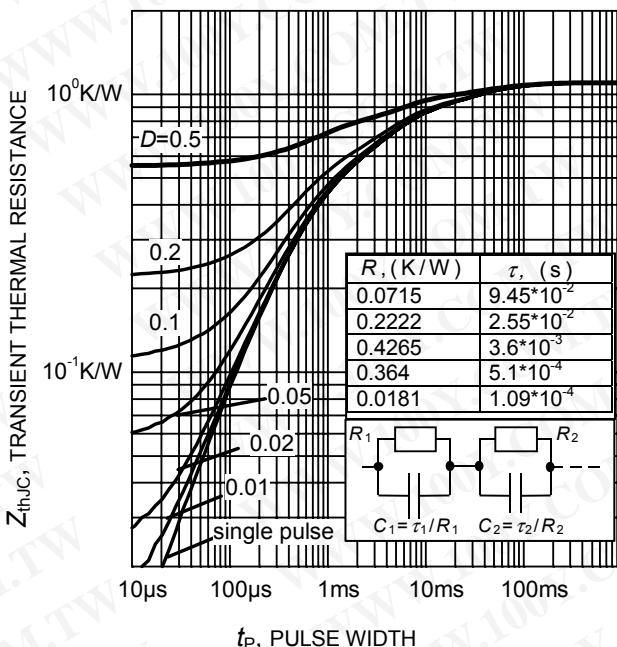
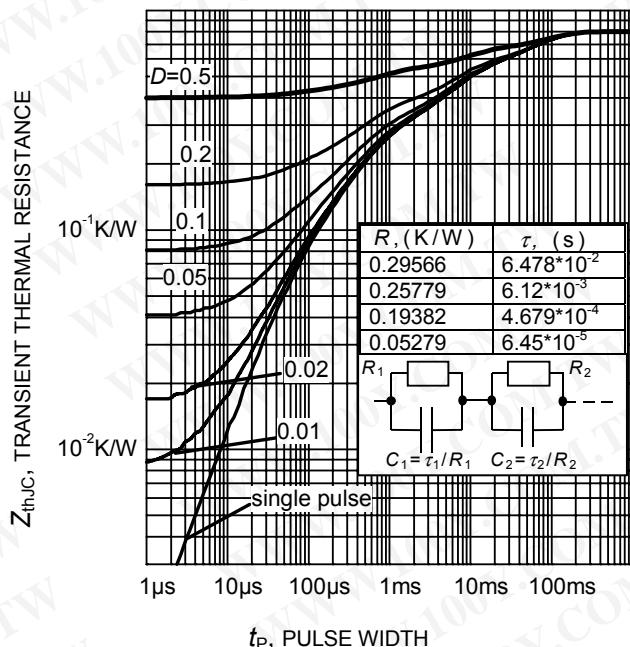


Figure 20. Short circuit withstand time as a
function of gate-emitter voltage
($V_{CE}=600$ V, start at $T_j=25^\circ$ C,
 $T_{jmax}<150^\circ$ C)

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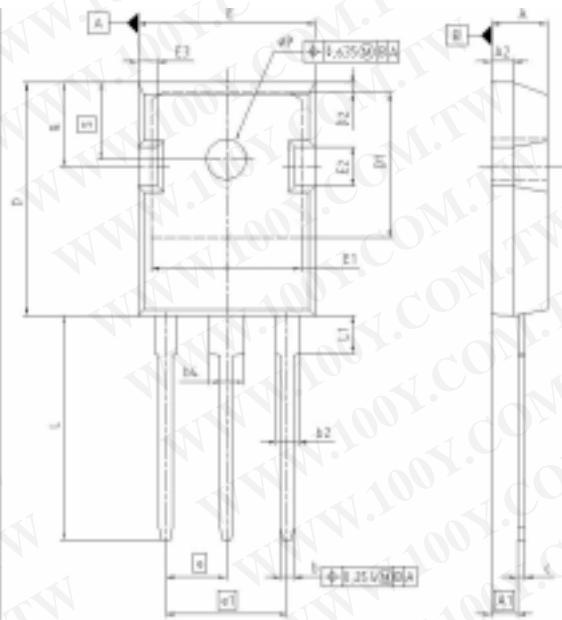


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PG-T0247-3-21



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.905	5.157	0.193	0.203
A1	2.273	2.527	0.092	0.098
A2	1.853	2.107	0.073	0.081
b	1.073	1.327	0.042	0.052
b2	1.903	2.306	0.075	0.094
b4	2.970	3.454	0.113	0.138
c	0.549	0.752	0.021	0.030
D	29.823	21.077	0.820	0.830
D1	17.323	17.831	0.682	0.702
D2	1.083	1.317	0.042	0.052
E	15.773	16.827	0.614	0.634
E1	15.893	14.847	0.547	0.557
E2	3.683	3.907	0.145	0.155
E3	1.463	1.997	0.069	0.078
F	5.450		0.215	
f1	10.900		0.430	
H	3		3	
L	20.093	20.307	0.793	0.799
L1	4.186	4.472	0.164	0.178
eP	3.558	3.661	0.140	0.144
Q	5.493	5.747	0.220	0.228
S	9.943	6.297	0.390	0.248

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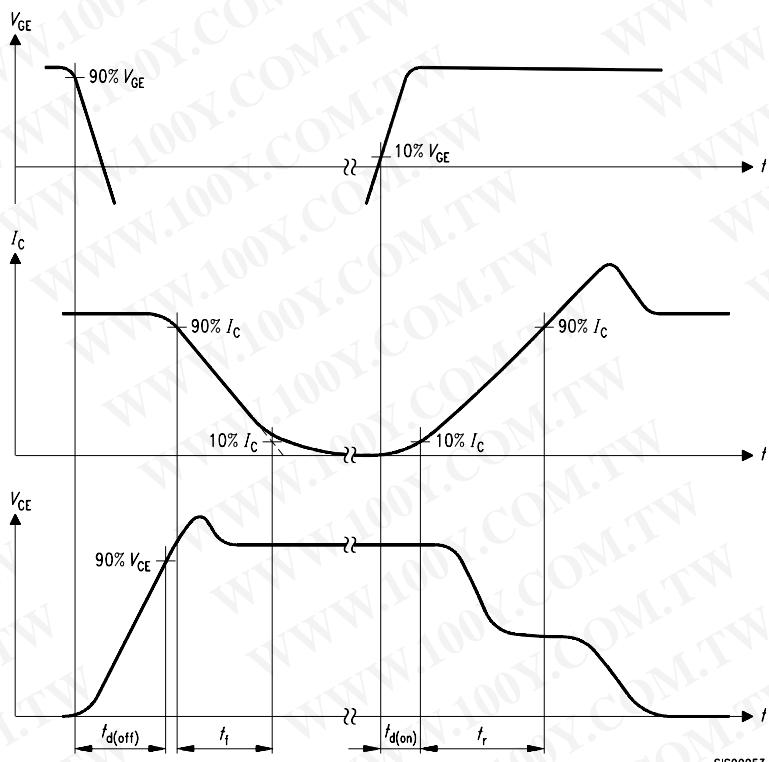


Figure A. Definition of switching times

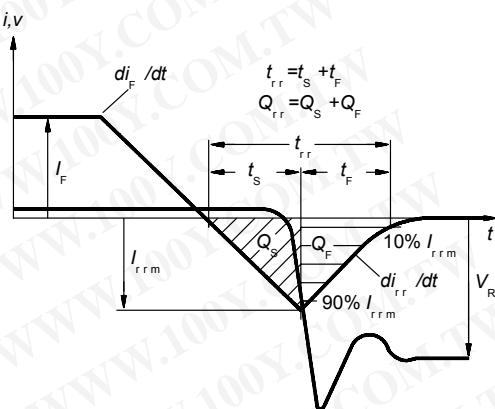


Figure C. Definition of diodes switching characteristics

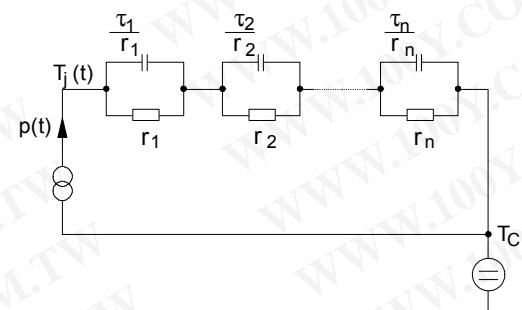


Figure D. Thermal equivalent circuit

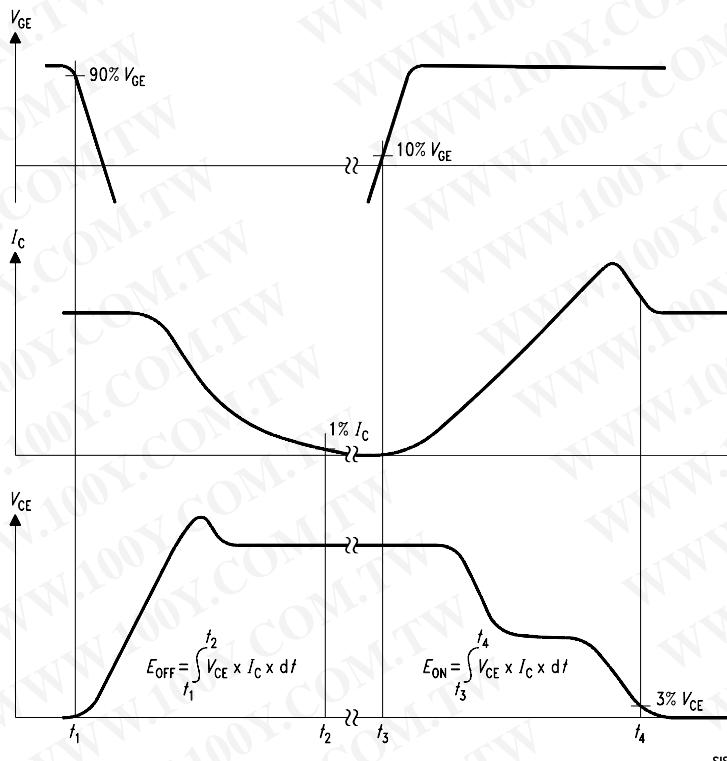


Figure B. Definition of switching losses

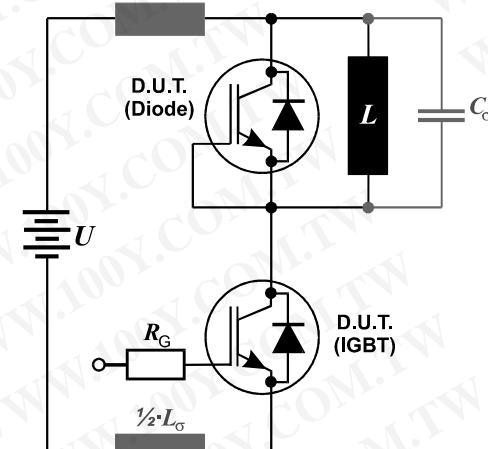


Figure E. Dynamic test circuit



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Soft Switching Series

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